CD54HC373, CD74HC373
<b>OCTAL TRANSPARENT D-TYPE LATCHES</b>
WITH 3-STATE OUTPUTS

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<ul> <li>2-V to 6-V V<sub>CC</sub> Operation</li> <li>Wide Operating Temperature Range of -55°C to 125°C</li> </ul>	CD54HC373 F PACKAGE CD74HC373 E OR M PACKAGE (TOP VIEW)
<ul> <li>Balanced Propagation Delays and Transition Times</li> </ul>	OE [ 1 20] V <sub>CC</sub> 1Q [ 2 19] 8Q
<ul> <li>Standard Outputs Drive up to 15 LS-TTL Loads</li> </ul>	1D [] 3 18 [] 8D 2D [] 4 17 [] 7D
<ul> <li>Significant Power Reduction Compared to LS-TTL Logic ICs</li> </ul>	2Q
description/ordering information	4D <b>3</b> 8 13 <b>5</b> D
The 'HC373 devices are octal transparent D-type	4Q [] 9 12 ] 5Q GND [ 10 11 ] LE

latches designed for 2-V to 6-V V<sub>CC</sub> operation. \_\_\_\_\_\_ When the latch-enable (LE) input is high, the Q outputs follow the data (D) inputs. When LE is low, the Q outputs are latched at the logic levels of the D inputs.

A buffered output-enable ( $\overline{OE}$ ) input can be used to place the eight outputs in either a normal logic state (high or low) or the high-impedance state. In the high-impedance state, the outputs neither load nor drive the bus lines significantly. The high-impedance state and increased drive provide the capability to drive bus lines without interface or pullup components.

OE does not affect the internal operations of the latches. Old data can be retained or new data can be entered while the outputs are in the high-impedance state.

To ensure the high-impedance state during power up or power down,  $\overline{OE}$  should be tied to V<sub>CC</sub> through a pullup resistor; the minimum value of the resistor is determined by the current-sinking capability of the driver.

TA	PACKAGET		ORDERABLE PART NUMBER	TOP-SIDE MARKING
	PDIP – E	Tube	CD74HC373E	CD74HC373E
–55°C to 125°C	5°C SOIC – M	Tube	CD74HC373M	HC373M
		Tape and reel	CD74HC373M96	
	CDIP – F	Tube	CD54HC373F3A	CD54HC373F3A

#### **ORDERING INFORMATION**

<sup>†</sup> Package drawings, standard packing quantities, thermal data, symbolization, and PCB design guidelines are available at www.ti.com/sc/package.



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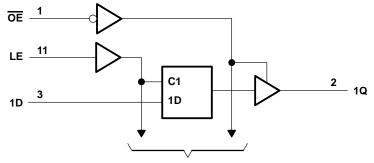


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FUNCTION TABLE (each latch)							
INPUTS OUTPUT							
OE	LE	D	Q				
L	Н	Н	Н				
L	н	L	L				
L	L	Х	Q <sub>0</sub> Z				
Н	Х	Х	Z				

### logic diagram (positive logic)



**To Seven Other Channels** 

#### absolute maximum ratings over operating free-air temperature range (unless otherwise noted)<sup>†</sup>

Supply voltage range, V <sub>CC</sub>	–0.5 V to 7 V
Input clamp current, $I_{IK}$ (V <sub>I</sub> < 0 or V <sub>I</sub> > V <sub>CC</sub> ) (see Note 1)	
Output clamp current, $I_{OK}$ (V <sub>O</sub> < 0 or V <sub>O</sub> > V <sub>CC</sub> ) (see Note 1)	±20 mA
Continuous output drain current per output, $I_O (V_O = 0 \text{ to } V_{CC})$	±35 mA
Continuous output source or sink current per output, $I_O (V_O = 0 \text{ to } V_{CC})$	±25 mA
Continuous current through V <sub>CC</sub> or GND	±50 mA
Package thermal impedance, $\theta_{JA}$ (see Note 2): E package	69°C/W
M package	58°C/W
Storage temperature range, T <sub>stg</sub>	–65°C to 150°C

<sup>†</sup> Stresses beyond those listed under "absolute maximum ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under "recommended operating conditions" is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

NOTES: 1. The input and output voltage ratings may be exceeded if the input and output current ratings are observed.

2. The package thermal impedance is calculated in accordance with JESD 51-7.



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#### recommended operating conditions (see Note 3)

			MIN	MAX	UNIT
VCC	Supply voltage		2	6	V
		$V_{CC} = 2 V$	1.5		
VIH	High-level input voltage	V <sub>CC</sub> = 4.5 V	3.15		V
		V <sub>CC</sub> = 6 V	4.2		
		$V_{CC} = 2 V$		0.5	
VIL		V <sub>CC</sub> = 4.5 V		1.35	V
		V <sub>CC</sub> = 6 V		1.8	
VI	Input voltage		0	VCC	V
٧ <sub>0</sub>	Output voltage		0	VCC	V
		V <sub>CC</sub> = 2 V		1000	
tt	Input transition (rise and fall) time	V <sub>CC</sub> = 4.5 V		500	ns
	Vcc			400	
Тд	Operating free-air temperature		-55	125	°C

NOTE 3: All unused inputs of the device must be held at V<sub>CC</sub> or GND to ensure proper device operation. Refer to the TI application report, *Implications of Slow or Floating CMOS Inputs*, literature number SCBA004.

# electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

PARAMETER	TEST CONDITIONS		Vcc	T <sub>A</sub> = 2	25°C	T <sub>A</sub> = - TO 12		T <sub>A</sub> = - TO 8		UNIT
				MIN	MAX	MIN	MAX	MIN	MAX	
			2 V	1.9		1.9		1.9		
		I <sub>OH</sub> = -20 μA	4.5 V	4.4		4.4		4.4		
VOH	$V_I = V_{IH} \text{ or } V_{IL}$		6 V	5.9		5.9		5.9		V
		I <sub>OH</sub> = -6 mA	4.5 V	3.98		3.7		3.84		
		I <sub>OH</sub> = -7.8 mA	6 V	5.48		5.2		5.34		
			2 V		0.1		0.1		0.1	
		I <sub>OL</sub> = 20 μA	4.5 V		0.1		0.1		0.1	
V <sub>OL</sub>	$V_I = V_{IH} \text{ or } V_{IL}$		6 V		0.1		0.1		0.1	V
		$I_{OL} = 6 \text{ mA}$	4.5 V		0.26		0.4		0.33	
		I <sub>OL</sub> = 7.8 mA	6 V		0.26		0.4		0.33	
lj	$V_{I} = V_{CC} \text{ or } 0$		6 V		±0.1		±1		±1	μA
I <sub>OZ</sub>	$V_{O} = V_{CC} \text{ or } 0$		6 V		±0.5		±10		±5	μA
ICC	$V_{I} = V_{CC} \text{ or } 0,$	I <sub>O</sub> = 0	6 V		8		160		80	μΑ
Ci					10		10		10	pF
Co					20		20		20	pF



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### timing requirements over recommended operating free-air temperature range (unless otherwise noted) (see Figure 1)

		Vcc	T <sub>A</sub> = 2	25°C	T <sub>A</sub> = - TO 12		T <sub>A</sub> = - TO 8		UNIT
			MIN	MAX	MIN	MAX	MIN	MAX	
		2 V	80		120		100		
tw Pulse duration, LE high	Pulse duration, LE high	4.5 V	16		24		20		ns
		6 V	14		20		17		
		2 V	50		75		65		
t <sub>su</sub>	Setup time, data before LE $\downarrow$	4.5 V	10		15		13		ns
		6 V	9		13		11		
		2 V	5		5		5		
t <sub>h</sub> I	Hold time, data after LE $\downarrow$	4.5 V	5		5		5		ns
		6 V	5		5		5		

#### switching characteristics over recommended operating free-air temperature range (unless otherwise noted) (see Figure 1)

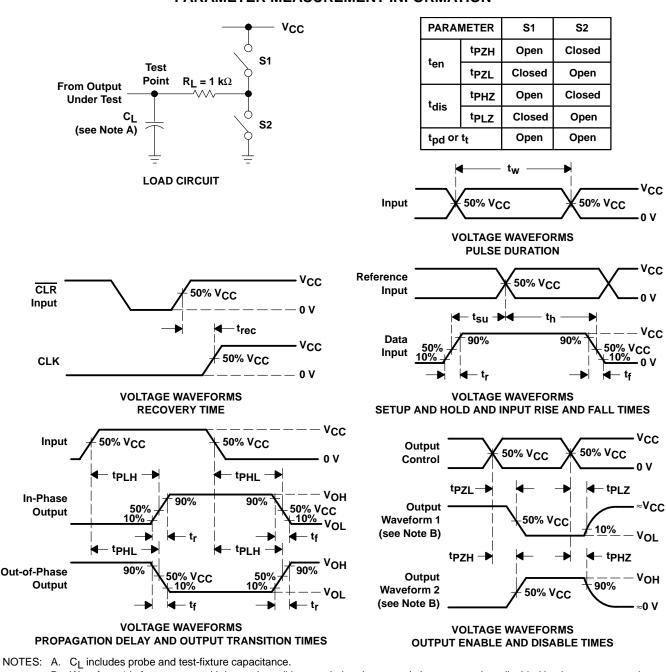
PARAMETER	FROM (INPUT)	TO (OUTPUT)	LOAD CAPACITANCE	v <sub>cc</sub>	T <sub>A</sub> = 25°C	T <sub>A</sub> = −55°C TO 125°C	T <sub>A</sub> = −40°C TO 85°C	UNIT	
		(001101)	CALACITANCE		MIN MAX	MIN MAX	MIN MAX		
				2 V	150	225	190		
	D	Q	C <sub>L</sub> = 50 pF	4.5 V	30	45	38		
÷.				6 V	26	38	33	ns	
<sup>t</sup> pd				2 V	175	265	220	115	
	LE	Q C <sub>L</sub> = 50 pF	C <sub>L</sub> = 50 pF	4.5 V	35	53	44		
				6 V	30	45	37		
				2 V	150	225	190		
ten	OE	Q	Q C <sub>L</sub> = 50 pF 4.5 V	30	45	38	ns		
				6 V	26	38	33		
				2 V	150	225	190		
<sup>t</sup> dis	ŌĒ	Q	C <sub>L</sub> = 50 pF	C <sub>L</sub> = 50 pF	4.5 V	30	45	38	ns
				6 V	26	38	33		
				2 V	60	90	75		
tt	Q C <sub>L</sub> = 5	C <sub>L</sub> = 50 pF	4.5 V	12	18	15	ns		
				6 V	10	15	13		

## operating characteristics, V<sub>CC</sub> = 5 V, T<sub>A</sub> = $25^{\circ}$ C

	PARAMETER TYP	UNIT
C <sub>pd</sub> Power dissipation cap	acitance 51	pF

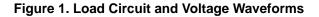


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#### PARAMETER MEASUREMENT INFORMATION

- - B. Waveform 1 is for an output with internal conditions such that the output is low except when disabled by the output control. Waveform 2 is for an output with internal conditions such that the output is high except when disabled by the output control. C. Phase relationships between waveforms were chosen arbitrarily. All input pulses are supplied by generators having the following
  - characteristics: PRR  $\leq$  1 MHz, Z<sub>O</sub> = 50  $\Omega$ , t<sub>r</sub> = 6 ns, t<sub>f</sub> = 6 ns. D. For clock inputs, fmax is measured with the input duty cycle at 50%.
  - E. The outputs are measured one at a time with one input transition per measurement.
  - F. t<sub>PLZ</sub> and t<sub>PHZ</sub> are the same as t<sub>dis</sub>.
  - G. tPZL and tPZH are the same as ten.
  - tpLH and tpHL are the same as tpd. H.
  - All parameters and waveforms are not applicable to all devices. Ι.





J (R-GDIP-T\*\*) 14 LEADS SHOWN

CERAMIC DUAL IN-LINE PACKAGE



NOTES: A. All linear dimensions are in inches (millimeters).

- B. This drawing is subject to change without notice.
- C. This package is hermetically sealed with a ceramic lid using glass frit.
- D. Index point is provided on cap for terminal identification only on press ceramic glass frit seal only.
- E. Falls within MIL STD 1835 GDIP1-T14, GDIP1-T16, GDIP1-T18 and GDIP1-T20.

# N (R-PDIP-T\*\*)

PLASTIC DUAL-IN-LINE PACKAGE

16 PINS SHOWN



NOTES:

- A. All linear dimensions are in inches (millimeters).B. This drawing is subject to change without notice.
- Falls within JEDEC MS-001, except 18 and 20 pin minimum body length (Dim A).
- $\triangle$  The 20 pin end lead shoulder width is a vendor option, either half or full width.



DW (R-PDSO-G20)

PLASTIC SMALL-OUTLINE PACKAGE



NOTES: A. All linear dimensions are in inches (millimeters).

B. This drawing is subject to change without notice.

C. Body dimensions do not include mold flash or protrusion not to exceed 0.006 (0,15).

D. Falls within JEDEC MS-013 variation AC.



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